

January 1992 Revised November 1999

# 74ABT2952 Octal Registered Transceiver

#### **General Description**

The ABT2952 is an octal registered transceiver. Two 8-bit back to back registers store data flowing in both directions between two bidirectional buses. Separate clock, clock enable and 3-STATE output enable signals are provided for each register. The output pins are guaranteed to source 32 mA and to sink 64 mA.

#### **Features**

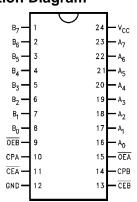
- Separate clock, clock enable and 3-STATE output enable provided for each register
- A and B output sink capability of 64 mA source capability of 32 mA
- Guaranteed output skew
- Guaranteed multiple output switching specifications
- Output switching specified for both 50 pF and 250 pF loads
- Guaranteed simultaneous switching noise level and dynamic threshold performance
- Guaranteed latchup protection
- High impedance glitch free bus loading during entire power up and power down cycle
- Nondestructive hot insertion capability

# **Ordering Code:**

Order Number	Package Number	Package Description
74ABT2952CSC	M24B	24-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide Body
74ABT2952CMSA	MSA24	24-Lead Shrink Small Outline Package (SSOP), EIAJ TYPE II, 5.3mm Wide
74ART2952CMTC	MTC24	24-Lead Thin Shrink Small Outline Package (TSSOP), IEDEC MO-153, 4.4mm Wide

Device also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

# **Connection Diagram**



# **Pin Descriptions**

Pin Names	Description
A <sub>0</sub> -A <sub>7</sub>	A-Register Inputs/B-Register
	3-STATE Outputs
B <sub>0</sub> –B <sub>7</sub>	B-Register Inputs/A-Register
	3-STATE Outputs
OEA	Output Enable A-Register
CPA	A-Register Clock
CEA	A-Register Clock Enable
OEB	Output Enable B-Register
СРВ	B-Register Clock
CEB	B-Register Clock Enable

# **Truth Table**

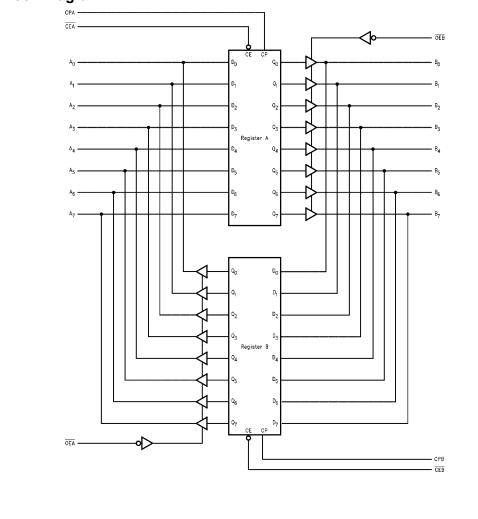
#### **Output Control**

ŌĒ	Internal Q	Output	Function
Н	X	Z	Disable Outputs
L	L	L	Enable Outputs
L	Н	Н	

#### Register Function Table (Applies to A or B Register)

	Inputs		Internal	Function
D	СР	CE	Q	Function
Х	Х	Н	NC	Hold Data
L	~	L	L	Load Data
Н	~	L	Н	

# **Block Diagram**



# **Absolute Maximum Ratings**(Note 1)

 $\begin{array}{ll} \mbox{Storage Temperature} & -65^{\circ}\mbox{C to } +150^{\circ}\mbox{C} \\ \mbox{Ambient Temperature under Bias} & -55^{\circ}\mbox{C to } +125^{\circ}\mbox{C} \\ \end{array}$ 

Junction Temperature under Bias -55°C to +150°C

 $V_{CC}$  Pin Potential to Ground Pin -0.5V to +7.0V Input Voltage (Note 2) -0.5V to +7.0V

Input Current (Note 2)

-30 mA to +5.0 mA

Voltage Applied to Any Output

in the Disable or

Power-Off State -0.5V to +5.5V in the HIGH State -0.5V to  $V_{CC}$ 

Current Applied to Output

in LOW State (Max) twice the rated  $I_{OL}$  (mA) DC Latchup Source Current -500 mA

Over Voltage Latchup (I/O) 10V

# Recommended Operating Conditions

Free Air Ambient Temperature -40°C to +85°C
Supply Voltage +4.5V to +5.5V

Minimum Input Edge Rate ( $\Delta V/\Delta t$ )

 Data Input
 50 mV/ns

 Enable Input
 20 mV/ns

 Clock Input
 100 mV/ns

**Note 1:** Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

#### **DC Electrical Characteristics**

Symbol	Parameter	Min	Тур	Max	Units	V <sub>CC</sub>	Conditions
V <sub>IH</sub>	Input HIGH Voltage	2.0			V		Recognized HIGH Signal
V <sub>IL</sub>	Input LOW Voltage			0.8	V		Recognized LOW Signal
V <sub>CD</sub>	Input Clamp Diode Voltage			-1.2	V	Min	I <sub>IN</sub> = -18 mA (Non I/O Pins)
V <sub>OH</sub>	Output HIGH Voltage	2.5					$I_{OH} = -3 \text{ mA } (A_n, B_n)$
		2.0					$I_{OH} = -32 \text{ mA } (A_n, B_n)$
V <sub>OL</sub>	Output LOW Voltage			0.55	V	Min	$I_{OL} = 64 \text{ mA } (A_n, B_n)$
V <sub>ID</sub>	Input Leakage Test	4.75			V	0.0	I <sub>ID</sub> = 1.9 μA (Non-I/O Pins)
							All Other Pins Grounded
I <sub>IH</sub>	Input HIGH Current			1	μА	Max	V <sub>IN</sub> = 2.7V (Non-I/O Pins) (Note 3)
				1	μΛ	iviax	V <sub>IN</sub> = V <sub>CC</sub> (Non-I/O Pins)
I <sub>BVI</sub>	Input HIGH Current Breakdown Test			7	μΑ	Max	V <sub>IN</sub> = 7.0V (Non-I/O Pins)
I <sub>BVIT</sub>	Input HIGH Current Breakdown Test (I/O)			100	μΑ	Max	$V_{IN} = 5.5V (A_n, B_n)$
I <sub>IL</sub>	Input LOW Current			-1	μА	Max	V <sub>IN</sub> = 0.5V (Non-I/O Pins) (Note 3)
				-1	μΛ	iviax	V <sub>IN</sub> = 0.0V (Non-I/O Pins)
I <sub>IH</sub> + I <sub>OZH</sub>	Output Leakage Current			10	μΑ	0V-5.5V	$V_{OUT} = 2.7V (A_n, B_n);$
							OEA or OEB = 2.0V
I <sub>IL</sub> + I <sub>OZL</sub>	Output Leakage Current			-10	μА	0V-5.5V	$V_{OUT} = 0.5V (A_n, B_n);$
							$\overline{OEA}$ or $\overline{OEB} = 2.0V$
Ios	Output Short-Circuit Current	-100		-275	mA	Max	$V_{OUT} = 0V (A_n, B_n)$
I <sub>CEX</sub>	Output HIGH Leakage Current			50	μА	Max	$V_{OUT} = V_{CC} (A_n, B_n)$
I <sub>ZZ</sub>	Bus Drainage Test			100	μΑ	0.0V	$V_{OUT} = 5.5V (A_n, B_n);$
							All Others GND
I <sub>CCH</sub>	Power Supply Current			250	μΑ	Max	All Outputs HIGH
I <sub>CCL</sub>	Power Supply Current			30	mA	Max	All Outputs LOW
I <sub>CCZ</sub>	Power Supply Current			50	μΑ	Max	Outputs 3-STATE;
							All Others GND
I <sub>CCT</sub>	Additional I <sub>CC</sub> /Input			2.5	mA	Max	V <sub>I</sub> = V <sub>CC</sub> - 2.1V; All Others
							at V <sub>CC</sub> or GND
I <sub>CCD</sub>	Dynamic I <sub>CC</sub> No Load			0.18	mA/MHz	Max	Outputs Open
	(Note 4)						$\overline{OEA}$ or $\overline{OEB} = GND$ ,
							Non-I/O = GND or V <sub>CC</sub>
							One Bit toggling, 50% duty cycle
							(Note 4)
	upropted but not tooted				1	1	L

Note 3: Guaranteed, but not tested.

Note 4: For 8-bit toggling,  $I_{CCD} < 1.4 \text{ mA/MHz}.$ 

# **DC Electrical Characteristics**

(SOIC Package)

Symbol	Parameter	Min	Тур	Max	Units	v <sub>cc</sub>	Conditions $C_L = 50 \text{ pF},$ $R_1 = 500\Omega$
V <sub>OLP</sub>	Quiet Output Maximum Dynamic V <sub>OL</sub>		0.6	0.8	V	5.0	T <sub>A</sub> = 25°C (Note 5)
V <sub>OLV</sub>	Quiet Output Minimum Dynamic V <sub>OL</sub>	-1.2	-1.0		V	5.0	T <sub>A</sub> = 25°C (Note 5)
V <sub>OHV</sub>	Minimum HIGH Level Dynamic Output Voltage	2.5	3.0		V	5.0	T <sub>A</sub> = 25°C (Note 6)
V <sub>IHD</sub>	Minimum HIGH Level Dynamic Input Voltage	2.0	1.7		V	5.0	T <sub>A</sub> = 25°C (Note 7)
V <sub>ILD</sub>	Maximum LOW Level Dynamic Input Voltage		1.2	0.8	V	5.0	T <sub>A</sub> = 25°C (Note 7)

Note 5: Max number of outputs defined as (n). n – 1 data inputs are driven 0V to 3V. One output at Low. Guaranteed, but not tested.

Note 6: Max number of outputs defined as (n). n – 1 data inputs are driven 0V to 3V. One output HIGH. Guaranteed, but not tested.

Note 7: Max number of data inputs (n) switching. n – 1 inputs switching 0V to 3V. Input-under-test switching: 3V to threshold (V<sub>ILD</sub>), 0V to threshold (V<sub>IHD</sub>). Guaranteed, but not tested.

#### **AC Electrical Characteristics**

(SOIC and SSOP Package)

Symbol	Parameter		$T_A = +25^{\circ}C$ $V_{CC} = +5.0V$ $C_L = 50 \text{ pF}$		V <sub>CC</sub> = 4.5	C to +85°C 5V to 5.5V 50 pF	Units
		Min	Тур	Max	Min	Max	
f <sub>MAX</sub>	Maximum Clock Frequency	200			200		MHz
t <sub>PLH</sub>	Propagation Delay	1.5	3.4	5.3	1.5	5.3	20
t <sub>PHL</sub>	CPA or CPB to	1.5	3.6	5.3	1.5	5.3	ns
	A <sub>n</sub> or B <sub>n</sub>						
t <sub>PZH</sub>	Output Enable Time	1.5	3.2	5.5	1.5	5.5	
t <sub>PZL</sub>	OEA or OEB to	1.5	3.5	5.5	1.5	5.5	ns
	A <sub>n</sub> or B <sub>n</sub>						
t <sub>PHZ</sub>	Output Disable Time	1.5	3.6	6.0	1.5	6.0	20
t <sub>PLZ</sub>	OEA or OEB to	1.5	3.2	6.0	1.5	6.0	ns
	A <sub>n</sub> or B <sub>n</sub>						

# **AC Operating Requirements**

		<b>T</b> <sub>A</sub> =	+25°C	T <sub>A</sub> = -40°	C to +85°C		
Symbol	Parameter	V <sub>CC</sub> =	+ <b>5.0V</b>	$V_{CC} = 4.5V$ to 5.5V $C_L = 50 \text{ pF}$		Units	
Syllibol	Farameter	C <sub>L</sub> =	50 pF				
		Min	Max	Min	Max	1	
t <sub>S</sub> (H)	Setup Time, HIGH	2.5		2.5		ns	
t <sub>s</sub> (L)	or LOW A <sub>n</sub> or B <sub>n</sub>	2.5		2.5		115	
	to CPA or CPB						
t <sub>H</sub> (H)	Hold Time, HIGH	1.5		1.5		ns	
t <sub>H</sub> (L)	or LOW A <sub>n</sub> or B <sub>n</sub>	1.5		1.5		115	
	to CPA or CPB						
t <sub>S</sub> (H)	Setup Time, HIGH	2.5		2.5			
t <sub>S</sub> (L)	or LOW CEA or CEB	2.5		2.5		ns	
	to CPA or CPB						
t <sub>H</sub> (H)	Hold Time, HIGH	1.5		1.5			
t <sub>H</sub> (L)	or LOW CEA or CEB	1.5		1.5		ns	
	to CPA or CPB						
t <sub>W</sub> (H)	Pulse Width,	3.0		3.0			
t <sub>W</sub> (L)	HIGH or LOW	3.0		3.0		ns	
	CPA or CPB						

#### **Extended AC Electrical Characteristics**

(SOIC Package)

Symbol	Parameter	V <sub>CC</sub> = 4.5 C <sub>L</sub> = 8 Outputs	$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ $V_{CC} = 4.5\text{V to } 5.5\text{V}$ $C_L = 50 \text{ pF}$ 8 Outputs Switching (Note 8)		$T_A = -40^{\circ}\text{C to} + 85^{\circ}\text{C}$ $V_{CC} = 4.5\text{V to} 5.5\text{V}$ $C_L = 250 \text{ pF}$ (Note 9)		$T_{A} = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ $V_{CC} = 4.5\text{V to } 5.5\text{V}$ $C_{L} = 250 \text{ pF}$ 8 Outputs Switching (Note 10)	
		Min	Max	Min	Max	Min	Max	
t <sub>PLH</sub>	Propagation Delay	1.5	6.0	2.0	8.0	2.5	10.5	
t <sub>PHL</sub>	CPA or CPB to A <sub>n</sub> or B <sub>n</sub>	1.5	6.0	2.0	8.0	2.5	10.5	ns
t <sub>PZH</sub>	Output Enable Time	1.5	6.0	2.0	8.0	2.5	11.5	
$t_{PZL}$	OEA or OEB to A <sub>n</sub> or B <sub>n</sub>	1.5	6.0	2.0	8.0	2.5	11.5	ns
t <sub>PHZ</sub>	Output Disable Time	1.5	6.0	(Note 11)		(Note 11)		no
$t_{PZL}$	OEA or OEB to A <sub>n</sub> or B <sub>n</sub>	1.5	6.0					ns

Note 8: This specification is guaranteed but not tested. The limits apply to propagation delays for all paths described switching in phase (i.e., all LOW-to-HIGH, HIGH-to-LOW, etc.).

Note 9: This specification is guaranteed but not tested. The limits represent propagation delay with 250 pF load capacitors in place of the 50 pF load capacitors in the standard AC load. This specification pertains to single output switching only.

Note 10: This specification is guaranteed but not tested. The limits represent propagation delays for all paths described switching in phase (i.e., all LOW-to-HIGH, HIGH-to-LOW, etc.) with 250 pF load capacitors in place of the 50 pF load capacitors in the standard AC load.

Note 11: The 3-STATE delays are dominated by the RC network (500 $\Omega$ , 250 pF) on the output and has been excluded from the datasheet.

#### Skew

(SOIC Package)

Symbol	Parameter	$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ $V_{CC} = 4.5\text{V} - 5.5\text{V}$ $C_L = 50 \text{ pF}$ 8 Outputs Switching (Note 12)	T <sub>A</sub> = -40°C to +85°C  V <sub>CC</sub> = 4.5V-5.5V  C <sub>L</sub> = 250 pF  8 Outputs Switching  (Note 13)	Units
t <sub>OSHL</sub>	Pin to Pin Skew	1.0	1.5	ns
(Note 14) COSLH (Note 14)	HL Transitions Pin to Pin Skew LH Transitions	1.0	2.0	ns
PS (Note 15)	Duty Cycle LH–HL Skew	2.0	4.5	ns
OST (Note 14)	Pin to Pin Skew LH/HL Transitions	2.1	4.5	ns
PV Note 16)	Device to Device Skew LH/HL Transitions	2.5	5.0	ns

Note 12: This specification is guaranteed but not tested. The limits apply to propagation delays for all paths described switching in phase (i.e., all LOW-to-HIGH, HIGH-to-LOW, etc.).

Note 13: This specification is guaranteed but not tested. The limits represent propagation delays with 250 pF load capacitors in place of the 50 pF load capacitors in the standard AC load.

Note 14: Skew is defined as the absolute value of the difference between the actual propagation delays for any two separate outputs of the same device. The specification applies to any outputs switching HIGH-to-LOW (t<sub>OSHL</sub>), LOW to HIGH (t<sub>OSLH</sub>), or any combination switching LOW-to-HIGH and/or HIGH-to-LOW (t<sub>OST</sub>). This specification is guaranteed but not tested.

Note 15: This describes the difference between the delay of the LOW-to-HIGH and the HIGH-to-LOW transition on the same pin. It is measured across all the outputs (drivers) on the same chip, the worst (largest delta) number is the guaranteed specification. This specification is guaranteed but not tested.

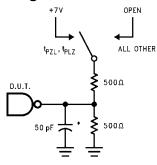
Note 16: Propagation delay variation for a given set of conditions (i.e., temperature and V<sub>CC</sub>) from device to device. This specification is guaranteed but not tested.

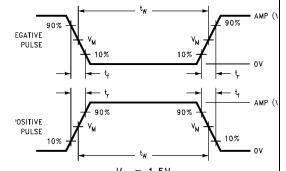
#### Capacitance

Symbol	Parameter	Тур	Units	Conditions
Symbol	Faiametei	Тур	Onits	T <sub>A</sub> = 25°C
C <sub>IN</sub>	Input Capacitance	5	pF	V <sub>CC</sub> = 0V (Non I/O Pins)
C <sub>I/O</sub> (Note 17)	Output Capacitance	11	pF	$V_{CC} = 5.0V (A_n, B_n)$

Note 17:  $C_{I\!/O}$  is measured at frequency f = 1 MHz, per MIL-STD-883, Method 3012.

# AC Loading





\*Includes jig and probe capacitance

FIGURE 1. Standard AC Test Load

 $V_{M} = 1.5V$  FIGURE 2. Test Input Signal Levels

Amplitude	Rep. Rate	t <sub>W</sub>	t <sub>r</sub>	t <sub>f</sub>
3.0V	1 MHz	500 ns	2.5 ns	2.5 ns

FIGURE 3. Input Signal Requirements

#### **AC Waveforms**

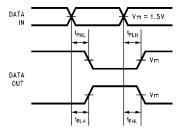


FIGURE 4. Propagation Delay Waveforms for Inverting and Non-Inverting Functions

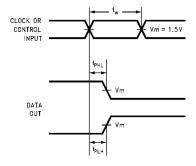


FIGURE 5. Propagation Delay, Pulse Width Waveforms

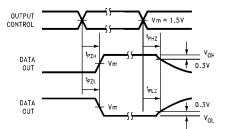
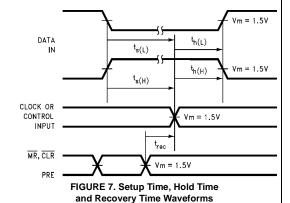
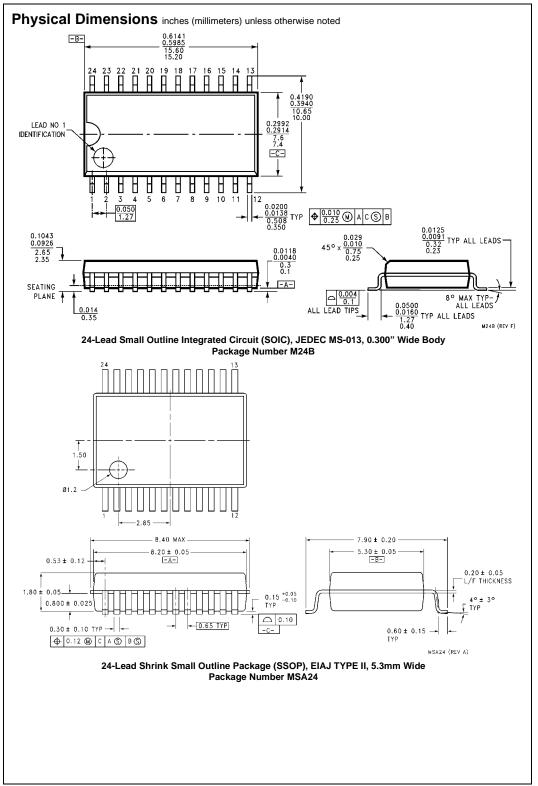
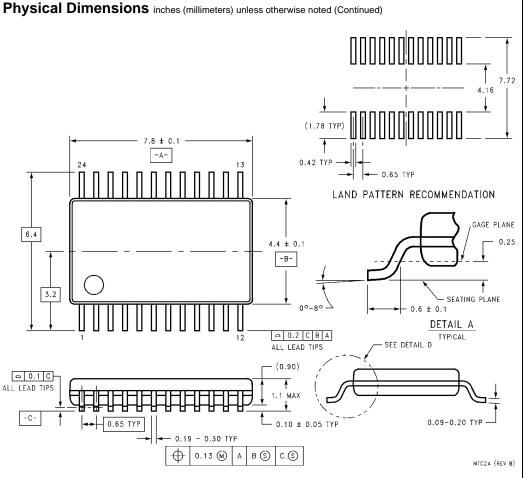


FIGURE 6. 3-STATE Output HIGH and LOW Enable and Disable Times



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24-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC24

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